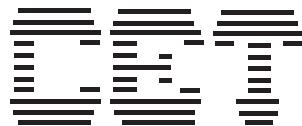


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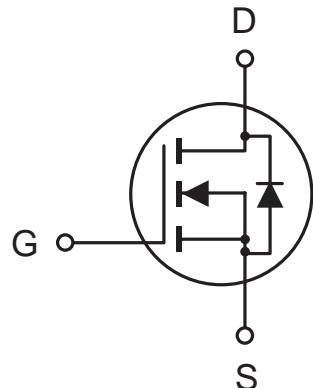
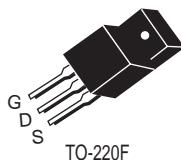
PRELIMINARY

N-Channel Logic Level Enhancement Mode Field Effect Transistor

FEATURES

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- 500V , 4.7A , $R_{DS(ON)}=0.85\Omega$ @ $V_{GS}=10V$.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handling capability.
- TO-220F full-pak for through hole



ABSOLUTE MAXIMUM RATINGS ($T_c=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	500	V
Gate-Source Voltage	V_{GS}	± 30	V
Drain Current-Continuous -Pulsed	I_D	4.7	A
	I_{DM}	15	A
Drain-Source Diode Forward Current	I_S	4.7	A
Maximum Power Dissipation @ $T_c=25^\circ C$ Derate above 25°C	P_D	48	W
		0.38	W/°C
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.6	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	65	°C/W

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ELECTRICAL CHARACTERISTICS (T_c=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
DRAIN-SOURCE AVALANCHE RATING^a						
Single Pulse Drain-Source Avalanche Energy	E _{AS}	V _{DD} = 50V, L = 24mH R _G = 25Ω		500		mJ
Maximum Drain-Source Avalanche Current	I _{AS}			8		A
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D = 250μA	500			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 500V, V _{GS} = 0V			25	μA
Gate-Body Leakage	I _{GSS}	V _{GS} = ±30V, V _{DS} = 0V			±100	nA
ON CHARACTERISTICS^a						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	2		4	V
Drain-Source On-State Resistance	R _{D(S)ON}	V _{GS} = 10V, I _D = 4.8A		0.76	0.85	Ω
On-State Drain Current	I _{D(ON)}	V _{GS} = 10V, V _{DS} = 10V	8			A
Forward Transconductance	g _F	V _{DS} = 50V, I _D = 6A		4		S
SWITCHING CHARACTERISTICS^b						
Turn-On Delay Time	t _{D(ON)}	V _{DD} = 250V, I _D = 8A, V _{GS} = 10V R _{GEN} = 9.1Ω		18		ns
Rise Time	t _r			25		ns
Turn-Off Delay Time	t _{D(OFF)}			105		ns
Fall Time	t _f			38		ns
Total Gate Charge	Q _g	V _{DS} = 400V, I _D = 8A, V _{GS} = 10V		56	65	nC
Gate-Source Charge	Q _{gs}			6		nC
Gate-Drain Charge	Q _{gd}			30		nC

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ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
DYNAMIC CHARACTERISTICS^b						
Input Capacitance	C_{iss}	$V_{DS}=25\text{V}$, $V_{GS}=0\text{V}$ $f=1.0\text{MHz}$	800			pF
Output Capacitance	C_{oss}		110			pF
Reverse Transfer Capacitance	C_{rss}		70			pF
DRAIN-SOURCE DIODE CHARACTERISTICS^a						
Diode Forward Voltage	V_{SD}	$V_{GS}=0\text{V}$, $I_S=8\text{A}$			1.5	V

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Notes

a.Pulse Test:Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2\%$.

b.Guaranteed by design, not subject to production testing.

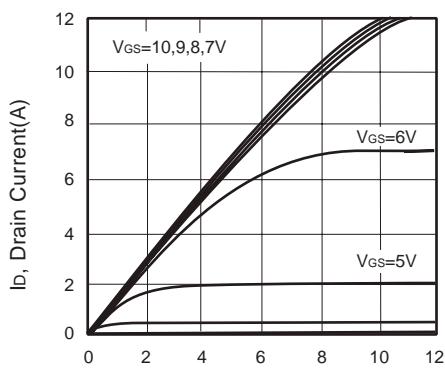


Figure 1. Output Characteristics

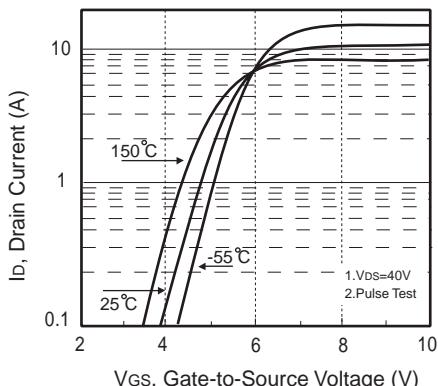


Figure 2. Transfer Characteristics

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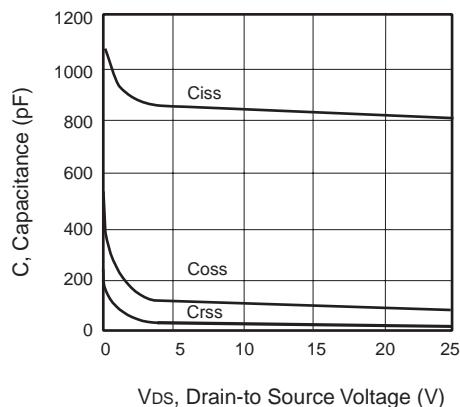
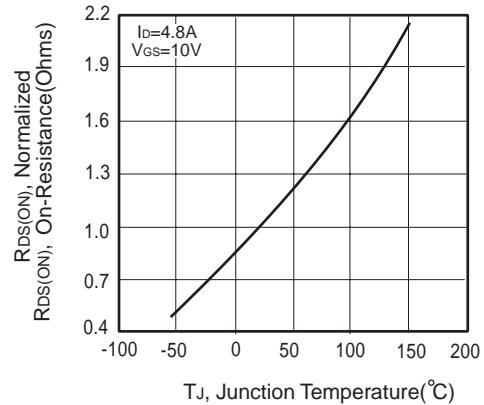


Figure 3. Capacitance



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Figure 4. On-Resistance Variation with Temperature

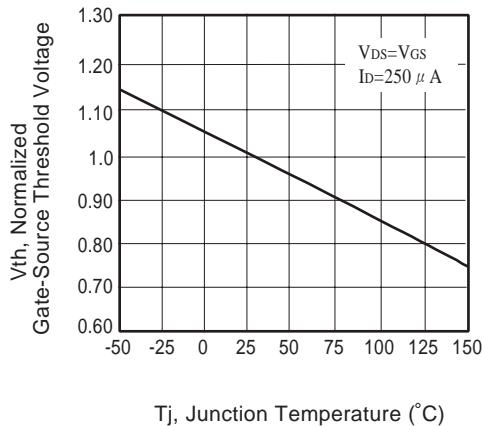


Figure 5. Gate Threshold Variation with Temperature

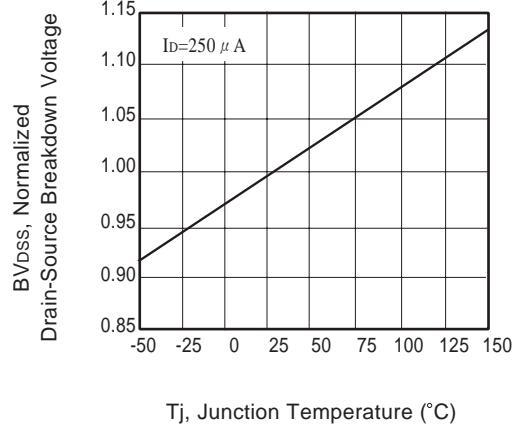


Figure 6. Breakdown Voltage Variation with Temperature

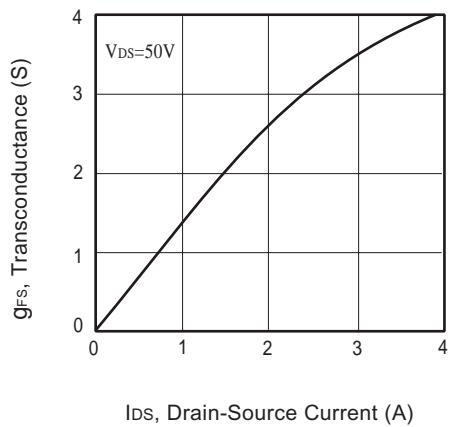


Figure 7. Transconductance Variation with Drain Current

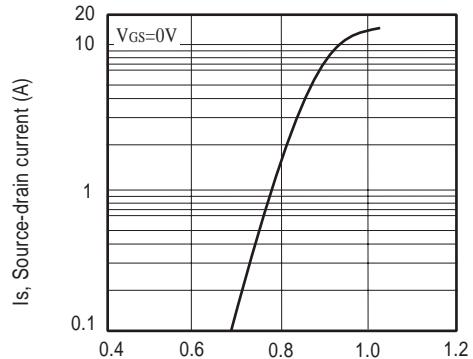


Figure 8. Body Diode Forward Voltage Variation with Source Current

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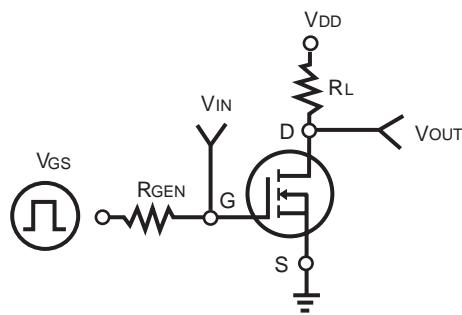
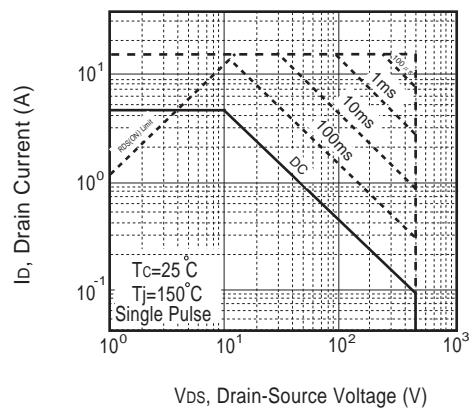
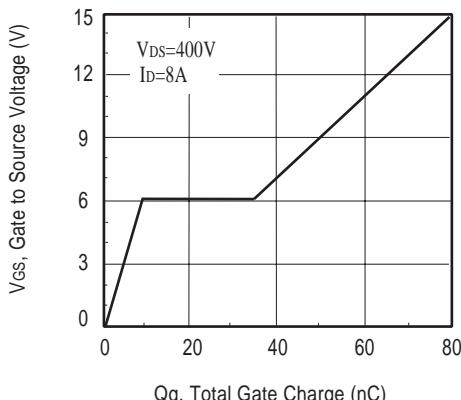


Figure 11. Switching Test Circuit

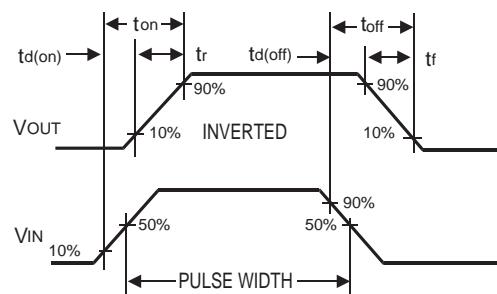


Figure 12. Switching Waveforms

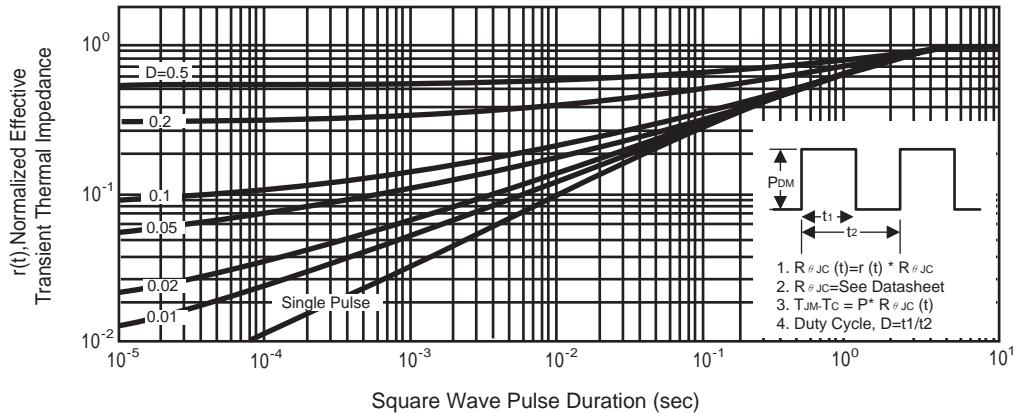


Figure 13. Normalized Thermal Transient Impedance Curve